

Low power consumption and high sensitivity omnipolar Hall chip

Description

SL6207 is a low-power, high-sensitivity full bipolar Hall switch chip designed and manufactured using CMOS technology. Integrated within the device are a voltage regulator, Hall voltage generator, small signal amplifier, chopper stabilizer, Schmitt trigger, and CMOS output driver. This chip exhibits excellent temperature stability, strong stress resistance, and high sensitivity, operating within a voltage range of 1.8V to 5.5V. It is available in TO92S through-hole and SOT23-3L surface-mount packages, both compliant with RoHS environmental standards.



Features

- Push-pull output
- ESD performance up to $\pm 6\text{kV}$
- Operating voltage: 1.8V to 5.5V
- Ideal for low-power battery-operated applications
- Full bipolar output switch

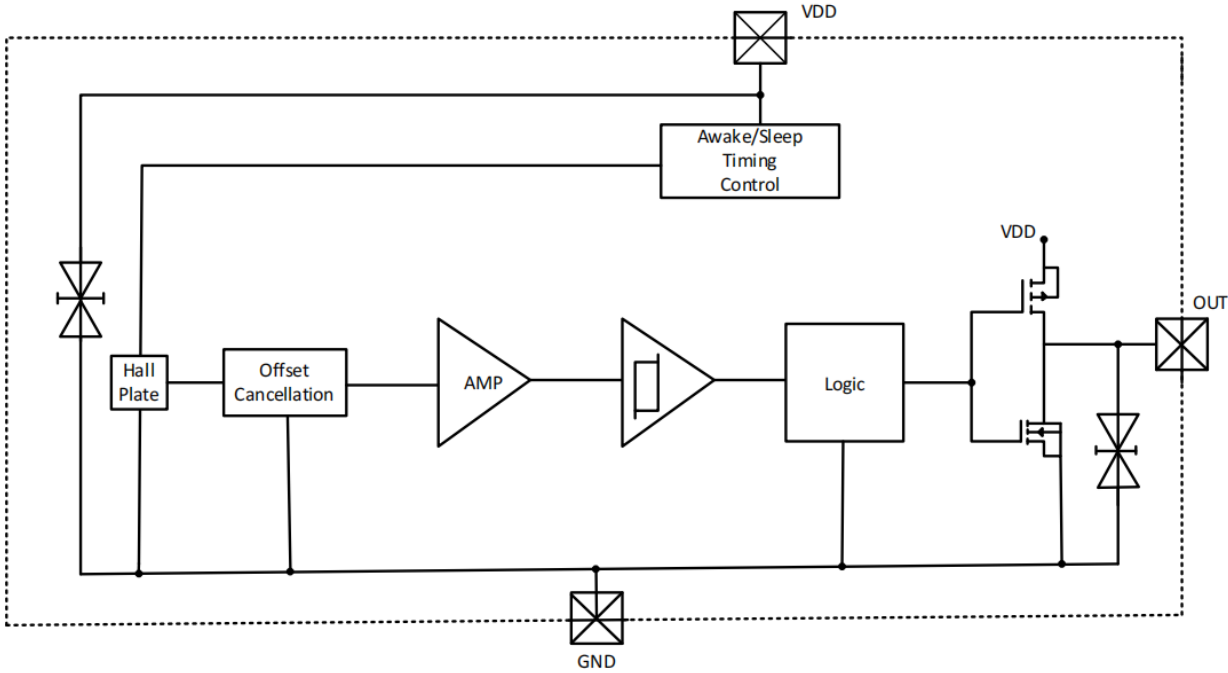
Applications

- Solid-state switch
- Bluetooth earbud charging case
- Portable disinfection box
- Laptop computer
- Magnetic sensor switch for low duty cycle applications
replacing reed switches
- Liquid level sensor
- Proximity switch

Packaging

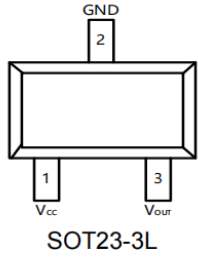
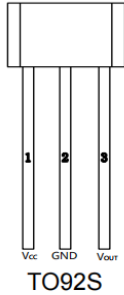
| Number | Package | Temperature Range | Product Packaging |
|----------|----------|-------------------|-------------------|
| SL6207-9 | TO92S | -40°C~85°C | 1000/bag |
| SL6207-3 | SOT23-3L | -40°C~85°C | 3000/roll |

Functional block diagram

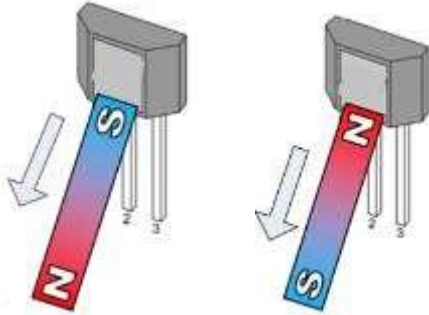


Pin information

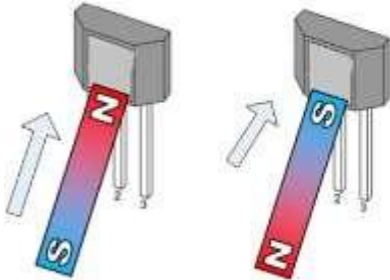
| Pin | Symbol | Description |
|-----|------------------|--------------|
| 1 | V _{CC} | power supply |
| 2 | GND | ground |
| 3 | V _{OUT} | output |



Applications

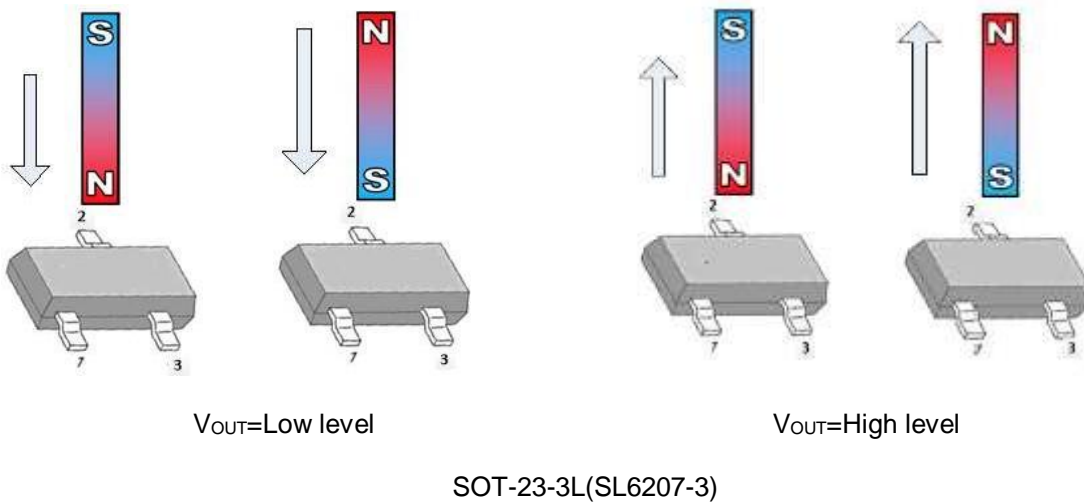


V_{OUT}=High level

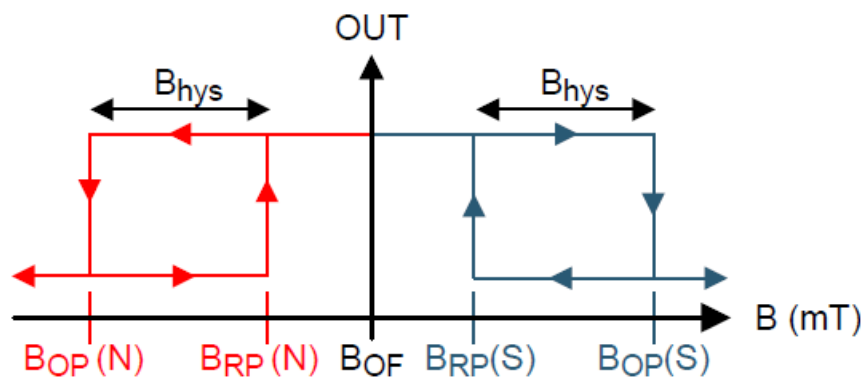


V_{OUT}=Low level

TO92S(SL6207-9)



Output state diagram



Limit parameters

| Parameter | Symbol | Value | Unit |
|------------------------------|-----------|---------|------|
| Voltage | V_{CC} | 6.0 | V |
| reverse voltage | V_{CCR} | -0.3 | V |
| output current | I_{OUT} | 5 | mA |
| output voltage | V_{OUT} | 6.0 | V |
| range of working temperature | T_A | -40~85 | °C |
| storage temperature range | T_S | -50~150 | °C |

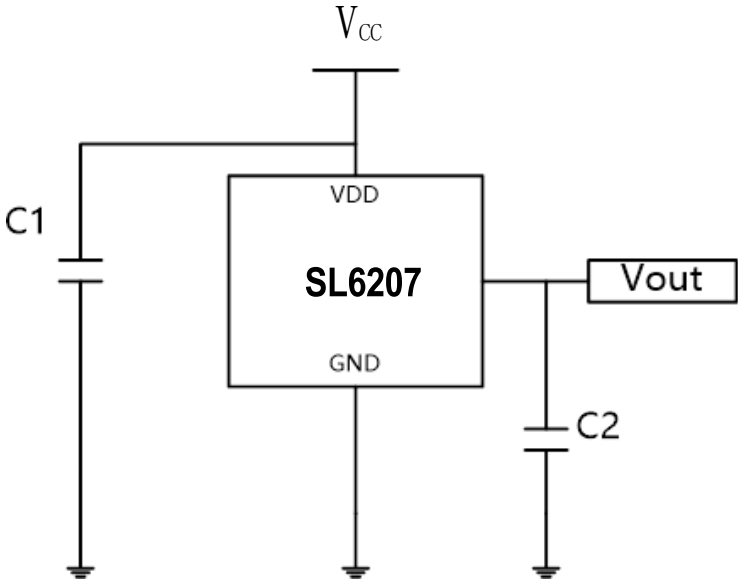
The absolute maximum ratings refer to the limits that the chip can withstand; exceeding these values may cause permanent damage to the chip

Electromagnetic properties (T_A=25°C, V_{CC}=3.0V)

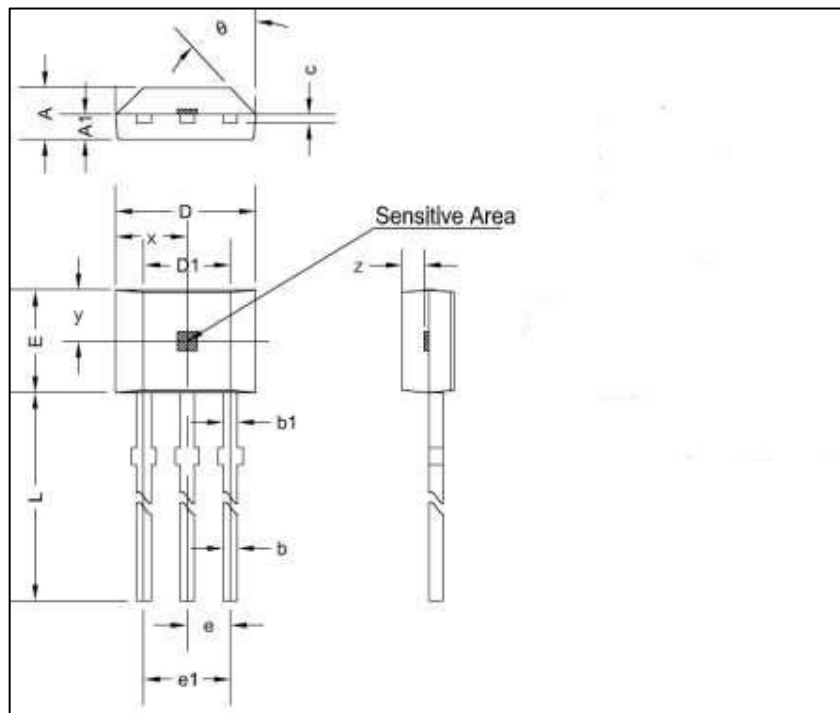
| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|------------------|------------------------------|----------------------|------|------|------|
| electrical properties | | | | | | |
| operating voltage | V _{CC} | | 1.8 | | 5.5 | V |
| output low voltage | V _{OL} | I _{OUT} =1mA | | | 0.2 | V |
| output high voltage | V _{OH} | I _{OUT} =-1mA | V _{CC} -0.2 | | | V |
| output current | I _{OUT} | when outputting low voltage | | | 3.0 | mA |
| | | when outputting high voltage | -2.0 | | | mA |
| working current | I _{awk} | when waking up | | 2.8 | | mA |
| average power supply current | I _{DD} | | | 5 | 10 | uA |
| wake-up mode time | T _{awk} | | | 20 | | us |
| sleep mode time | T _p | | | 20 | | ms |
| working frequency | F _w | | | 50 | | Hz |
| magnetic properties | | | | | | |
| working point | Bop | | | ±22 | | Gs |
| release point | Brp | | | ±14 | | Gs |
| hysteresis | Bhys | Bop-Brp | | 8 | | Gs |

Application circuit

C1=0.1uF,C2=100pF

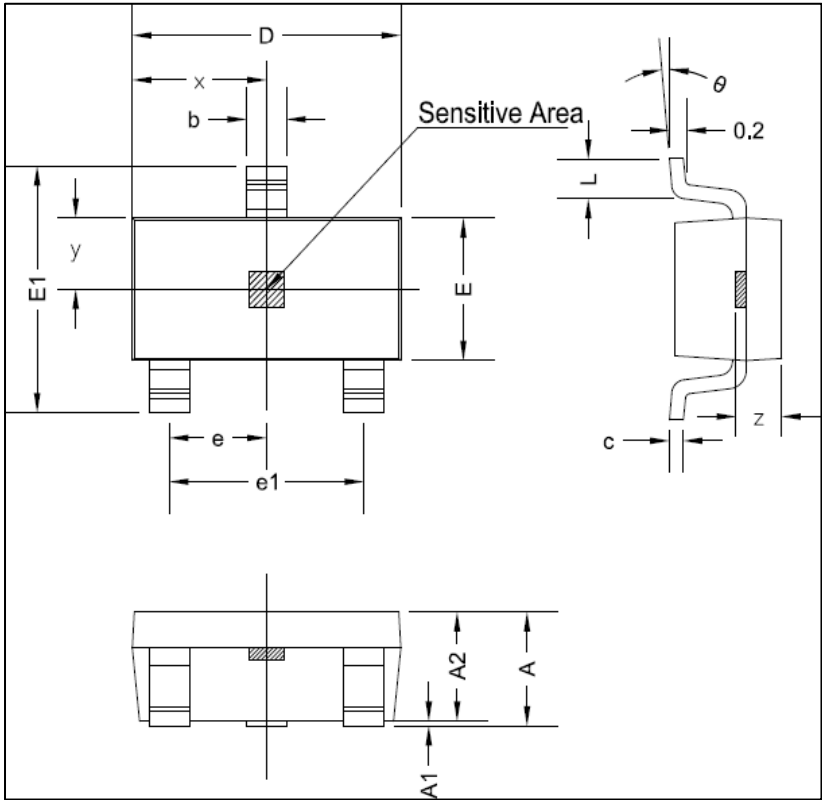


Typical application circuit

Packaging information
TO92S Package dimensions


| Symbol | Dimensions (mm) | | Dimensions (inch) | |
|--------|-----------------|--------|-------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.420 | 1.670 | 0.056 | 0.066 |
| A1 | 0.660 | 0.860 | 0.026 | 0.034 |
| b | 0.350 | 0.560 | 0.014 | 0.022 |
| b1 | 0.400 | 0.550 | 0.016 | 0.022 |
| C | 0.360 | 0.510 | 0.014 | 0.020 |
| D | 3.900 | 4.200 | 0.154 | 0.165 |
| D1 | 2.970 | 3.270 | 0.117 | 0.129 |
| E | 2.900 | 3.280 | 0.114 | 0.129 |
| e | 1.270TYP | | 0.050TYP | |
| e1 | 2.440 | 2.640 | 0.096 | 0.104 |
| L | 13.500 | 15.500 | 0.531 | 0.610 |
| x | 2.025TYP | | 0.080TYP | |
| y | 1.545TYP | | 0.061TYP | |
| z | 0.500TYP | | 0.020TYP | |
| theta | 45°TYP | | 45°TYP | |

SOT23-3L Package Dimensions



| Symbol | Dimensions (mm) | | Dimensions (inch) | |
|--------|-----------------|-------|-------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 1.050 | 1.250 | 0.041 | 0.049 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 1.050 | 1.150 | 0.041 | 0.045 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.100 | 0.200 | 0.004 | 0.008 |
| D | 2.820 | 3.020 | 0.111 | 0.119 |
| E | 1.500 | 1.700 | 0.059 | 0.067 |
| E1 | 2.650 | 2.950 | 0.104 | 0.116 |
| e | 0.950TYP | | 0.037TYP | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.300 | 0.600 | 0.012 | 0.024 |
| x | 1.460TYP | | 0.057TYP | |
| y | 0.800TYP | | 0.032TYP | |
| z | 0.600TYP | | 0.024TYP | |
| theta | 0° | 8° | 0° | 8° |

Notice

- Hall sensors are sensitive devices, and electrostatic protection measures should be taken during both usage and storage.
- During installation and use, minimize mechanical stress applied to the device package and leads.
- It is recommended to keep soldering temperatures below 350°C and duration under 5 seconds.
- To ensure the safety and stability of the Hall chip, prolonged operation beyond specified parameters is not advisable.